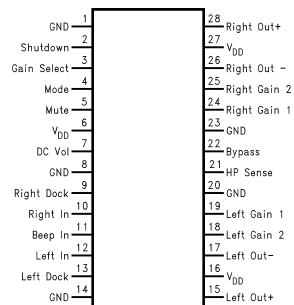


Connection Diagram (Continued)

TSSOP Package



DS100139-2

Top View

Order Number **LM4835MT**

See NS Package Number **MTC28** for TSSOP

Order Number **LM4835MTE**

See NS Package Number **MXA28A** for Exposed-DAP

TSSOP

Absolute Maximum Ratings (Note 10)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	6.0V
Storage Temperature	-65°C to +150°C
Input Voltage	-0.3V to $V_{DD} + 0.3V$
Power Dissipation	Internally limited
ESD Susceptibility (Note 12)	2000V
ESD Susceptibility (Note 13)	200V
Junction Temperature	150°C
Soldering Information	
Small Outline Package	
Vapor Phase (60 sec.)	215°C
Infrared (15 sec.)	220°C

See AN-450 "Surface Mounting and their Effects on Product Reliability" for other methods of soldering surface mount devices.

θ_{JC} (typ)—LQA028AA (Note A)	TBD°C/W
θ_{JA} (typ)—LQA028AA (Note B)	TBD°C/W
θ_{JC} (typ)—MTC28	20°C/W
θ_{JA} (typ)—MTC28	80°C/W
θ_{JC} (typ)—MXA28A	2°C/W
θ_{JA} (typ)—MXA28A (Note 4)	41°C/W
θ_{JA} (typ)—MXA28A (Note 3)	54°C/W
θ_{JA} (typ)—MXA28A (Note 5)	59°C/W
θ_{JA} (typ)—MXA28A (Note 6)	93°C/W

Operating Ratings

Temperature Range	$-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$
Supply Voltage	$2.7V \leq V_{DD} \leq 5.5V$

Electrical Characteristics for Entire IC

(Notes 7, 10)

The following specifications apply for $V_{DD} = 5V$ unless otherwise noted. Limits apply for $T_A = 25^{\circ}\text{C}$.

Symbol	Parameter	Conditions	LM4835		Units (Limits)
			Typical (Note 14)	Limit (Note 15)	
V_{DD}	Supply Voltage			2.7	V (min)
				5.5	V (max)
I_{DD}	Quiescent Power Supply Current	$V_{IN} = 0V, I_O = 0A$	15	30	mA (max)
I_{SD}	Shutdown Current	$V_{pin\ 2} = V_{DD}$	0.7	2.0	μA (max)
V_{IH}	Headphone Sense High Input Voltage			4	V (min)
V_{IL}	Headphone Sense Low Input Voltage			0.8	V (max)

Electrical Characteristics for Volume Attenuators

(Notes 7, 10)

The following specifications apply for $V_{DD} = 5V$. Limits apply for $T_A = 25^{\circ}\text{C}$.

Symbol	Parameter	Conditions	LM4835		Units (Limits)
			Typical (Note 14)	Limit (Note 15)	
C_{RANGE}	Attenuator Range	Gain with $V_{pin\ 7} = 5V$	0	± 0.5	dB (max)
		Attenuation with $V_{pin\ 7} = 0V$	-81	-80	dB (min)
A_M	Mute Attenuation	$V_{pin\ 5} = 5V$, Bridged Mode	-88	-80	dB (min)
		$V_{pin\ 5} = 5V$, Single-Ended Mode	-88	-80	dB (min)

Electrical Characteristics for Single-Ended Mode Operation

(Notes 7, 10)

The following specifications apply for $V_{DD} = 5V$. Limits apply for $T_A = 25^{\circ}\text{C}$.

Symbol	Parameter	Conditions	LM4835		Units (Limits)
			Typical (Note 14)	Limit (Note 15)	
P_O	Output Power	THD = 1.0%; $f = 1\text{kHz}$; $R_L = 32\Omega$	85		mW
		THD = 10%; $f = 1\text{kHz}$; $R_L = 32\Omega$	95		mW
THD+N	Total Harmonic Distortion+Noise	$V_{OUT} = 1V_{RMS}$, $f=1\text{kHz}$, $R_L = 10k\Omega$, $A_{VD} = 1$	0.065		%

Electrical Characteristics for Single-Ended Mode Operation (Continued)

(Notes 7, 10)

The following specifications apply for $V_{DD} = 5V$. Limits apply for $T_A = 25^\circ C$.

Symbol	Parameter	Conditions	LM4835		Units (Limits)
			Typical (Note 14)	Limit (Note 15)	
PSRR	Power Supply Rejection Ratio	$C_B = 1.0 \mu F$, $f = 120 \text{ Hz}$, $V_{RIPPLE} = 200 \text{ mVrms}$	58		dB
SNR	Signal to Noise Ratio	$P_{OUT} = 75 \text{ mW}$, $R_L = 32\Omega$, A-Wtd Filter	102		dB
X_{talk}	Channel Separation	$f = 1 \text{ kHz}$, $C_B = 1.0 \mu F$	65		dB

Electrical Characteristics for Bridged Mode Operation

(Notes 7, 10)

The following specifications apply for $V_{DD} = 5V$, unless otherwise noted. Limits apply for $T_A = 25^\circ C$.

Symbol	Parameter	Conditions	LM4835		Units (Limits)
			Typical (Note 14)	Limit (Note 15)	
V_{OS}	Output Offset Voltage	$V_{IN} = 0V$	5	30	mV (max)
P_O	Output Power	THD + N = 1.0%; $f = 1 \text{ kHz}$; $R_L = 3\Omega$ (Note 8)	2.2		W
		THD + N = 1.0%; $f = 1 \text{ kHz}$; $R_L = 4\Omega$ (Note 9)	2		W
		THD = 0.5% (max); $f = 1 \text{ kHz}$; $R_L = 8\Omega$	1.1	1.0	W (min)
		THD+N = 10%; $f = 1 \text{ kHz}$; $R_L = 8\Omega$	1.5		W
THD+N	Total Harmonic Distortion+Noise	$P_O = 1W$, $20 \text{ Hz} < f < 20 \text{ kHz}$, $R_L = 8\Omega$, $A_{VD} = 2$	0.3		%
		$P_O = 340 \text{ mW}$, $R_L = 32\Omega$	1.0		%
PSRR	Power Supply Rejection Ratio	$C_B = 1.0 \mu F$, $f = 120 \text{ Hz}$, $V_{RIPPLE} = 200 \text{ mVrms}$; $R_L = 8\Omega$	74		dB
SNR	Signal to Noise Ratio	$V_{DD} = 5V$, $P_{OUT} = 1.1W$, $R_L = 8\Omega$, A-Wtd Filter	93		dB
X_{talk}	Channel Separation	$f = 1 \text{ kHz}$, $C_B = 1.0 \mu F$	70		dB

Note 3: The θ_{JA} given is for an MXA28A package whose exposed-DAP is soldered to an exposed 2 in^2 piece of 1 ounce printed circuit board copper.

Note 4: The θ_{JA} given is for an MXA28A package whose exposed-DAP is soldered to a 2 in^2 piece of 1 ounce printed circuit board copper on a bottom side layer through 21 8mil vias.

Note 5: The θ_{JA} given is for an MXA28A package whose exposed-DAP is soldered to an exposed 1 in^2 piece of 1 ounce printed circuit board copper.

Note 6: The θ_{JA} given is for an MXA28A package whose exposed-DAP is not soldered to any copper.

Note 7: All voltages are measured with respect to the ground pins, unless otherwise specified. All specifications are tested using the typical application as shown in Figure 1.

Note 8: When driving 3Ω loads from a 5V supply the LM4835LQ and LM4835MTE must be mounted to the circuit board and forced-air cooled.

Note 9: When driving 4Ω loads from a 5V supply the LM4835LQ and LM4835MTE must be mounted to the circuit board.

Note 10: *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur. *Operating Ratings* indicate conditions for which the device is functional, but do not guarantee specific performance limits. *Electrical Characteristics* state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Marshall Chiu feels there are better ways to obtain "More Wattage in the Cottage." Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 11: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$. For the LM4835LQ and LM4835MT, $T_{JMAX} = 150^\circ C$, and the typical junction-to-ambient thermal resistance, when board mounted, is $80^\circ C/W$ for the MTC28 package and $TBD^\circ C/W$ for the LM4835LQ package.

Note 12: Human body model, 100 pF discharged through a 1.5 k Ω resistor.

Note 13: Machine Model, 220 pF–240 pF discharged through all pins.

Note 14: Typicals are measured at $25^\circ C$ and represent the parametric norm.

Note 15: Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

Typical Application

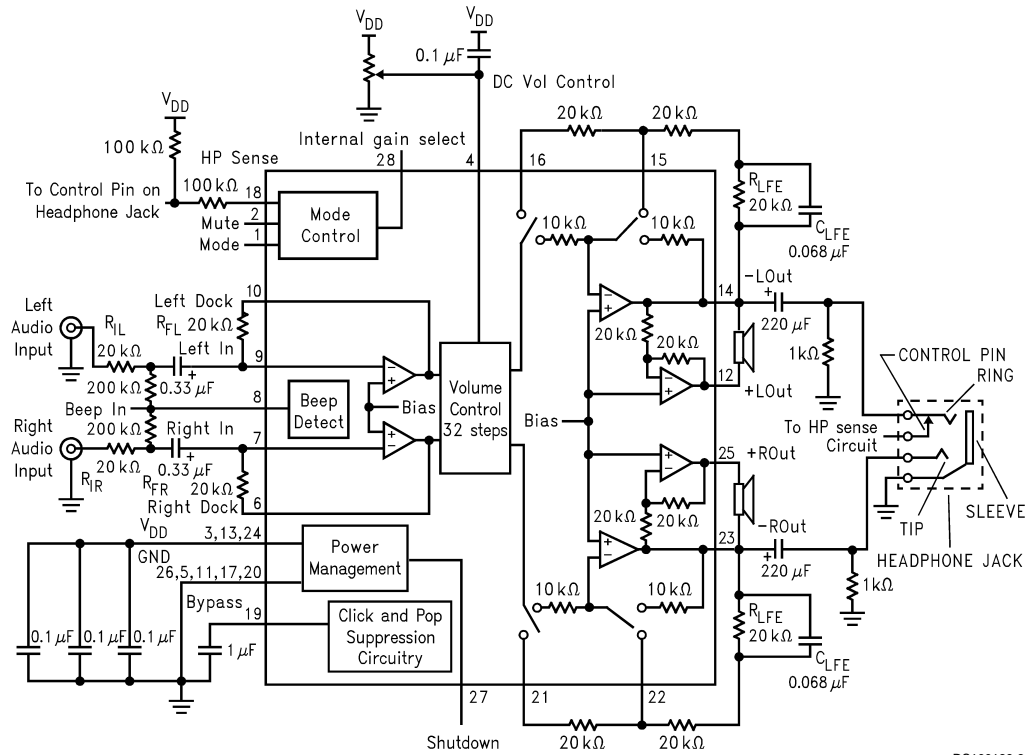


FIGURE 2. Typical Application Circuit

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Truth Table for Logic Inputs (Note 16)

Mute	Mode	HP Sense	DC Vol. Control	Bridged Output	Single-Ended Output
0	0	0	Fixed Level	Vol. Fixed	—
0	0	1	Fixed Level	Muted	Vol. Fixed
0	1	0	Adjustable	Vol. Changes	—
0	1	1	Adjustable	Muted	Vol. Changes
1	X	X	—	Muted	Muted

Note 16: If system beep is detected on the Beep In pin (pin 11), the system beep will be passed through the bridged amplifier regardless of the logic of the Mute and HP sense pins.

Application Information (Continued)

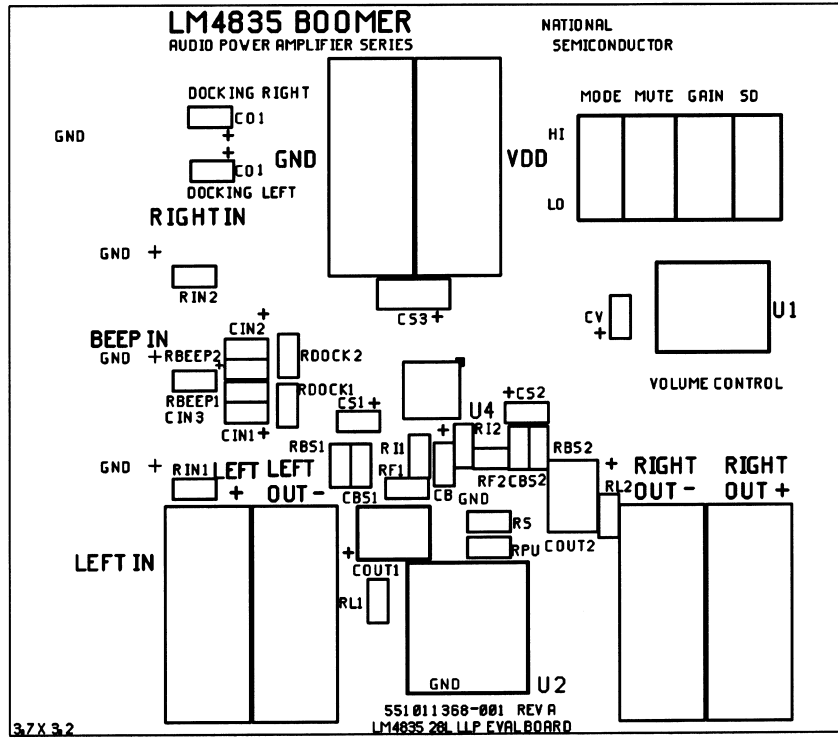


Figure 6. Recommended LQ PC Board Layout:
Component-Side Silkscreen

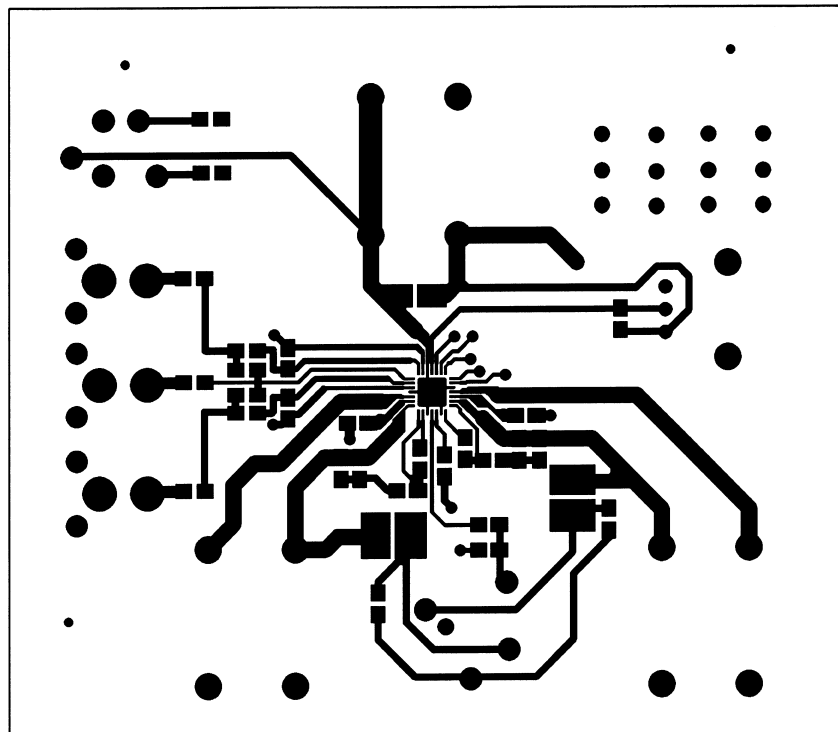
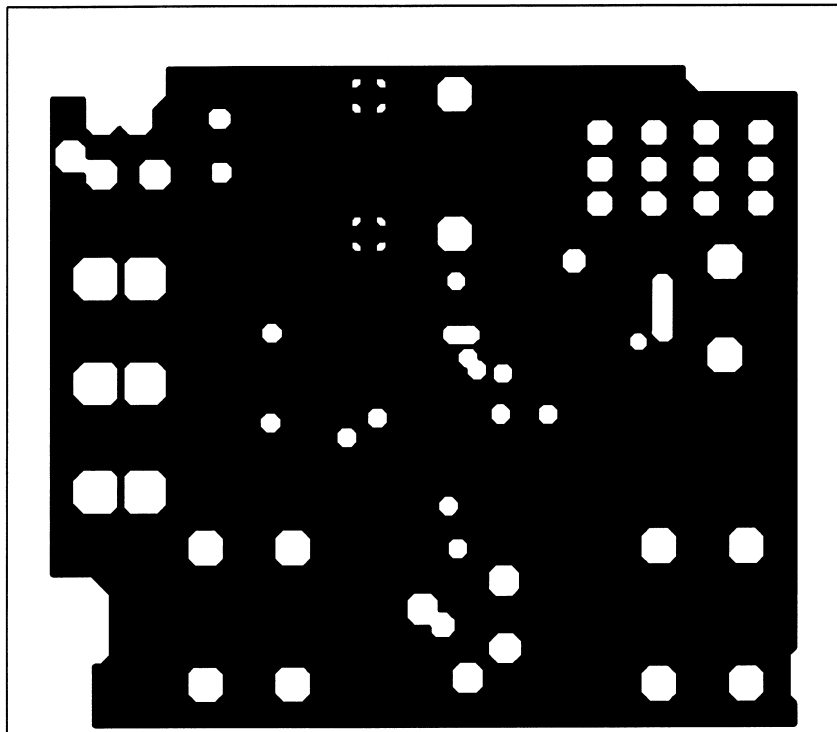


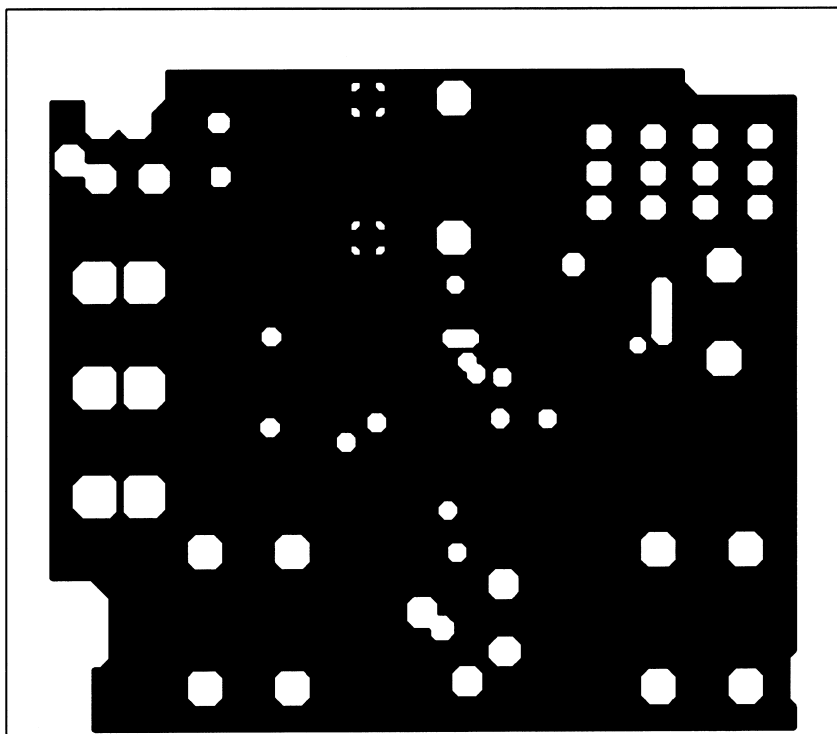
Figure 7. Recommended LQ PC Board Layout:
Component-Side Layout

Application Information (Continued)



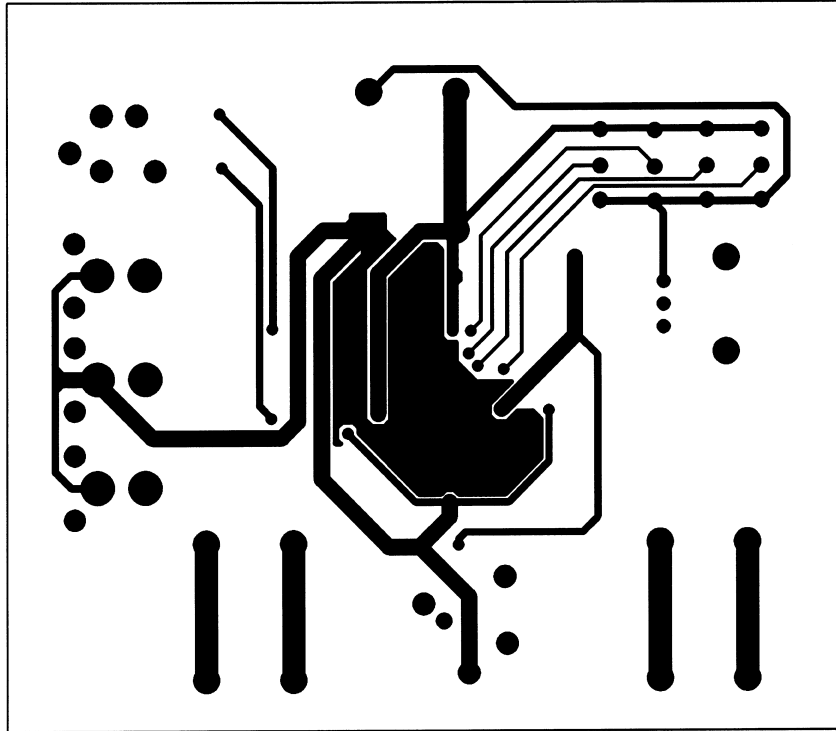
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**Figure 8. Recommended LQ PC Board Layout:
Upper Inner-Layer Layout**



DS100139-80

**Figure 9. Recommended LQ PC Board Layout:
Lower Inner-Layer Layout**

Application Information (Continued)

DS100139-81

**Figure 10. Recommended LQ PC Board Layout:
Bottom-Side Layout**